GOVERNMENT OF INDIA MINISTRY OF EXTERNAL AFFAIRS

RAJYA SABHA UNSTARRED QUESTION NO-69

ANSWERED ON- 20/07/2023

STATE VISIT OF THE PRIME MINISTER TO THE UNITED STATES

69. DR. JOHN BRITTAS

Will the Minister of EXTERNAL AFFAIRS be pleased to state :-

- (a) the details of Agreements/MoUs executed with US Government and business groups during the recent visit of the Prime Minister to the US;
- (b) the total value of contracts, and amounts to be spent/undertakings to be performed by Indian Government/Indian companies to bring such proposals into fruition;
- (c) the details of Agreement/proposal by Micron Technology to set up an outsourced semiconductor assembly and testing plant in Gujarat entailing an investment of \$2.75 billion;
- (d) whether it is a fact that Micron Technology proposes to invest \$825 million, while the rest will be a combination of incentives/support from the Central and State Governments; and
- (e) the details of such incentives/support?

ANSWER

THE MINISTER OF STATE IN THE MINISTRY OF EXTERNAL AFFAIRS

(SHRI V. MURALEEDHARAN)

- (a & b) During Prime Minister's visit to U.S.A, Indian Space Research Organization [ISRO] signed the Artemis Accords with U.S. National Aeronautics and Space Administration [NASA] for cooperation in civil exploration of outer space for peaceful purposes.
- (c to e) A project of Micron Technology Inc. has been approved under the Government of India's "Modified scheme", for setting up of a Compound Semiconductors/ Silicon Photonics/ Sensors Fab/ Discrete Semiconductors Fab and Semiconductor Assembly, Testing, Marking and Packaging (ATMP)/ Outsourced Semiconductor Assembly and Test (OSAT) facility in India.

Micron Technology Inc. has announced an investment of US\$ 825 million in setting up of a semiconductor assembly and test facility in India.

All incentives and support to the project will be as per existing schemes of the Government of India and the State Government of Gujarat.
